

Vishay Siliconix

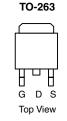
N-Channel 40-V (D-S) 175 °C MOSFET

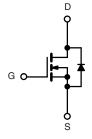
PRODUCT SUMMARY			
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)	
40	0.0035 at V _{GS} = 10 V	110 ^a	

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature







Ordering Information: SUM110N04-04 SUM110N04-04-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATIN	GS T _C = 25 °C, unless o	therwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	20	v	
Continuous Drain Current ($T_J = 175 \ ^{\circ}C$)	T _C = 25 °C	I _D	110 ^a		
	T _C = 125 °C	D'D	107 ^a	A	
Pulsed Drain Current		I _{DM}	350		
Avalanche Current		I _{AR}	60	1	
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	180	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	Р	250 ^c	14/	
	T _A = 25 °C ^d		3.75	— w	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	(PCB Mount) ^d	R _{thJA}	40	°C/W	
Junction-to-Case		R _{thJC}	0.6	0/11	

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When mounted on 1" square PCB (FR-4 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	40			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = 20 V$			100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA	
	I _{DSS}	V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 125 °C			50		
		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			Α	
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 30 A		0.0028	0.0035		
	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C			0.0055	Ω	
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C			0.006		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	30			S	
Dynamic ^b	•						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		6800		pF	
Output Capacitance	C _{oss}			1110			
Reverse Transfer Capacitance	C _{rss}			690			
Total Gate Charge ^c	Qg			140	200	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_{D} = 110 A		35			
Gate-Drain Charge ^c	Q _{gd}			55			
Turn-On Delay Time ^c	t _{d(on)}			20	35		
Rise Time ^c	t _r	V_{DD} = 30 V, R _L = 0.47 Ω I _D \cong 110 A, V _{GEN} = 10 V, R _g = 2.5 Ω		115	175	ns	
Turn-Off Delay Time ^c	t _{d(off)}			75	115		
Fall Time ^c	t _f			85	130		
Source-Drain Diode Ratings and Ch	aracteristics 7	_C = 25 °C ^b					
Continuous Current	۱ _S			110		•	
Pulsed Current	I _{SM}				350	A	
Forward Voltage ^a	V _{SD}	I _F = 110 A, V _{GS} = 0 V		1.1	1.4	V	
Reverse Recovery Time	t _{rr}			50	80	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 110 A, di/dt = 100 A/μs		2	3	Α	
Reverse Recovery Charge	Q _{rr}			0.05	0.12	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

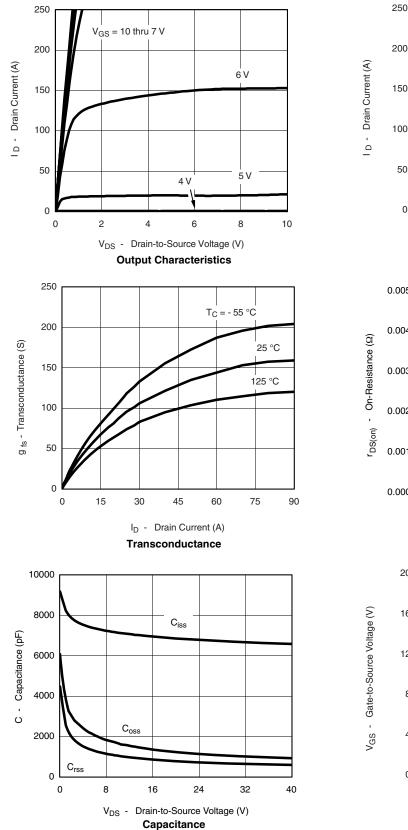
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

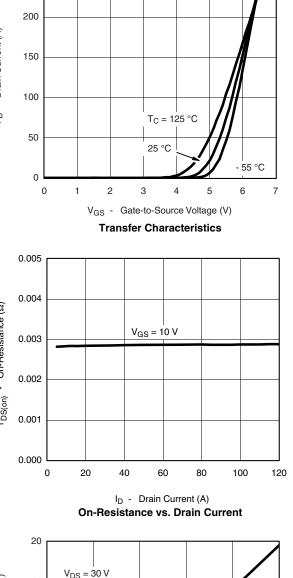


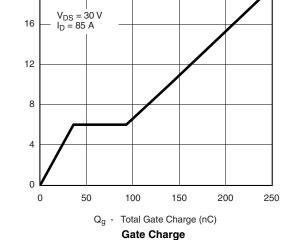
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

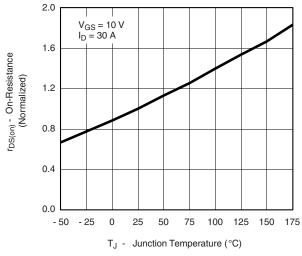




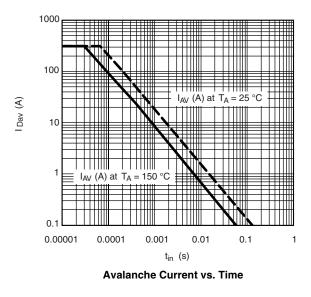


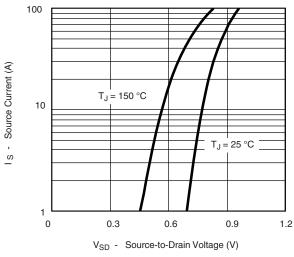
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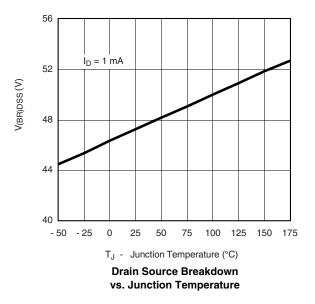


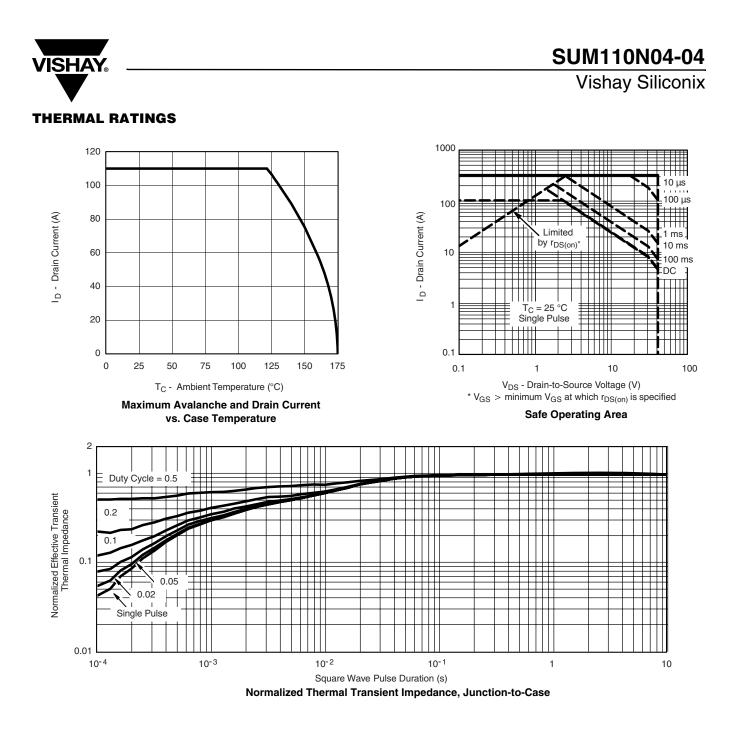
On-Resistance vs. Junction Temperature





Source-Drain Diode Forward Voltage





Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72077.



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